

**KIOXIA Corporation**

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PHONE: 81-45-890-2538  
Date: July 14<sup>th</sup>, 2021  
Ref. No.: 21MQ-G006-1(E)

To: \_\_\_\_\_

## Product Change Notification

This letter is to inform you of the following changes.

### 1. Affected products

Product type: 32nm 4Gbit 1-stack SLC NAND TSOP-packaged products  
Part number: TC58NVG2S0FTA00, TC58NVG2S0FTA10

### 2. Reason for change

The production of the current lead frame will be discontinued due to end-of life (EOL).

### 3. Change description

The supplier of the lead frame will be changed.

There is no change of the lead frame processing method, structure, environmental data and the specification of the products.

### 4. Change schedule

Production using the changed lead frame is targeted to start from January 2022 (running change).

### 5. Reliability data

Moisture Resistance Test (MRT), Highly Accelerated Stress Test (HAST) and Temperature Cycling (TC) results will be available in early August of 2021.

### 6. Evaluation samples

Evaluation samples will be available after August of 2021.

If you need evaluation samples, please place an order by August 13<sup>th</sup>, 2021.

### 7. Method to identify changed products

You can identify the change by the additional code that is printed on the labels.

	Additional Code
Current Product	B4M or B4H
Changed Product	B4A

### 8. Customer response

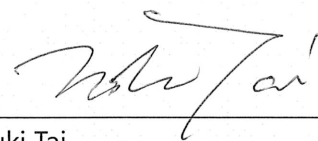
Please acknowledge above and send your acceptance notification by September 30<sup>th</sup>, 2021.

If we do not receive your response by the above date, we will deem this change accepted.

If you have any inquiry of this subject or a request for evaluation samples, please contact our sales representatives.

We appreciate your understanding and cooperation.

Sincerely,



Nobuyuki Tai  
Group Manager  
Memory Customer Quality Engineering Group  
Memory Q&R Engineering Department  
KIOXIA Corporation